

Data Sheet May 5, 2005 FN8087.1

Precision 1.25V and 2.50V, 1.08µ-Watt, High Precision FGA™ Voltage References

The ISL60007 FGA™ voltage references are extremely low power, very high precision analog voltage references fabricated in Intersil's proprietary Floating Gate Analog technology. The ISL60007 features low supply voltage operation at ultra-low 400nA operating current resulting in typical 1.08µW power consumption.

In addition, the ISL60007 family features guaranteed initial accuracy as low as ± 0.5 mV, temperature coefficients as tight as 3ppm/°C and long-term stability of 10ppm/ $\sqrt{1}$ kHrs.

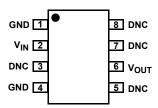
The initial accuracy and thermal stability performance of the ISL60007 family plus the low power consumption eliminates the need to compromise accuracy and thermal stability for reduced power consumption making it an ideal high resolution, low power data conversion system.

Ordering Information

PART NUMBER	TEMP. RANGE (°C)	PACKAGE	GRADE	V _{OUT} OPTION
ISL60007CIB812	-40 to +85	8 Ld SOIC	±0.5mV, 5ppm/°C	1.250V
ISL60007DIB812	-40 to +85	8 Ld SOIC	±1.0mV, 10ppm/°C	1.250V
ISL60007BIB825	-40 to +85	8 Ld SOIC	±0.5mV, 3ppm/°C	2.500V
ISL60007CIB825	-40 to +85	8 Ld SOIC	±0.5mV, 5ppm/°C	2.500V
ISL60007DIB825	-40 to +85	8 Ld SOIC	±1.0mV, 10ppm/°C	2.500V

Pinout

ISL60007 (8 LD SOIC) TOP VIEW



Pin Descriptions

PIN NAME	DESCRIPTION
GND	Ground Connection
V _{IN}	Power Supply Input Connection
V _{OUT}	Voltage Reference Output Connection
DNC	Do Not Connect; Internal Connection - Must Be Left Floating

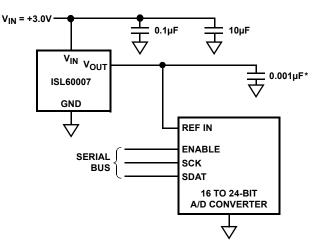
Features

Reference Voltage 1.25V, and 2.50V
Absolute Initial Accuracy Options ±0.5mV, & ±1.0mV
• 1.08µW typical Power Consumption
Supply Voltage Range 2.7V to 5.5V
• Ultra-Low Supply Current
• Low Temperature Coefficient Options 3ppm/°C 5ppm/°C, & 10ppm/°C
• Long Term Stability 10ppm/√1kHrs
7mA Source & Sink Current
• ESD Protection 5kV (Human Body Model)
Standard 8 Ld SOIC Packaging
• Temperature Range

Applications

- · High Resolution A/Ds & D/As
- · Digital Meters
- · Bar Code Scanners
- · Mobile Communications
- · PDA's and Notebooks
- Battery Management Systems
- · Medical Systems

Typical Application



^{*}Also see Figure 29 in Applications Information.

Absolute Maximum Ratings

Recommended Operating Conditions

Storage Temperature Range	65°C to +125°C
Max Voltage V _{IN} to Gnd	0.5V to +6.5V
Max Voltage V _{OUT} to Gnd (10s)	0.5V to +3.50V
Voltage on "DNC" pins No connections p	permitted to these pins.
Lead Temperature, soldering (10s)	+225°C

Temperature Range (Industrial)....-40°C to 85°C

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

Electrical Specifications Operating Conditions: $V_{IN} = 3.0V$, $I_{OUT} = 0$ mA, $C_{OUT} = 0.001 \mu$ F, $T_A = -40$ to +85°C, Unless Otherwise Specified.

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
1.250V OUTPU	IT VOLTAGE		<u>'</u>			
V _{OUT}	Output Voltage			1.250		V
V _{OA}	V _{OUT} Accuracy @ T _A = 25°C	ISL60007C12	-0.5		+0.5	mV
		ISL60007D12	-1.0		+1.0	mV
TC V _{OUT}	Output Voltage Temperature Coefficient (Note 1)	ISL60007C12			5	ppm/°C
		ISL60007D12			10	ppm/°C
V _{IN}	Input Voltage Range		2.7		5.5	V
I _{IN}	Supply Current			400	800	nA
$\Delta V_{OUT}/\Delta V_{IN}$	Line Regulation	$+2.7V \le V_{IN} \le +5.5V$		30	200	μV/V
$\Delta V_{OUT}/\Delta I_{OUT}$	Load Regulation	Sourcing: 0mA ≤ I _{OUT} ≤ 7mA		15	50	μV/mA
		Sinking: $-7mA \le I_{OUT} \le 0mA$		50	150	μV/mA
ΔV _{OUT} /Δt	Long Term Stability	T _A = 25°C		10		ppm/√1kHrs
$\Delta V_{OUT}/\Delta T_{A}$	Thermal Hysteresis (Note 2)	ΔT _A = 125°C		50		ppm
I _{SC}	Short Circuit Current (Note 3)	T _A = 25°C		40	80	mA
V_N	V _{OUT} Noise	0.1Hz ≤ f ≤ 10Hz		30		μV _{P-P}
2.500V OUTPU	JT VOLTAGE			1	1	
V _{OUT}	Output Voltage			2.500		V
V _{OA}	V _{OUT} Accuracy @ T _A = 25°C	ISL60007B25	-0.5		+0.5	mV
		ISL60007C25	-0.5		+0.5	mV
		ISL60007D25	-1.0		+1.0	mV
TC V _{OUT}	Output Voltage Temperature Coefficient (Note 1)	ISL60007B25			3	ppm/°C
		ISL60007C25			5	ppm/°C
		ISL60007D25			10	ppm/°C
V _{IN}	Input Voltage Range		2.7		5.5	V
I _{IN}	Supply Current			400	800	nA
$\Delta V_{OUT}/\Delta V_{IN}$	Line Regulation	+2.7V ≤ V _{IN} ≤ +5.5V		30	200	μV/V
ΔV _{OUT} /ΔI _{OUT}	Load Regulation	Sourcing: $0mA \le I_{OUT} \le 7mA$		15	50	μV/mA
		Sinking: $-7mA \le I_{OUT} \le 0mA$		50	150	μV/mA
ΔV _{OUT} /Δt	Long Term Stability (Note 4)	T _A = 25°C		10		ppm/√1kHrs
$\Delta V_{OUT}/\Delta T_{A}$	Thermal Hysteresis (Note 2)	ΔT _A = 125°C		50		ppm

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Electrical Specifications

Operating Conditions: V_{IN} = 3.0V, I_{OUT} = 0mA, C_{OUT} = 0.001 μ F, T_A = -40 to +85 $^{\circ}$ C, Unless Otherwise Specified. (Continued)

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
I _{SC}	Short Circuit Current (Note 3)	T _A = 25°C, V _{OUT} tied to Gnd		40	80	mA
V _N	Output Voltage Noise	0.1Hz ≤ f ≤ 10Hz		30		μV _{p-p}

NOTES:

- 1. Over the specified temperature range. Temperature coefficient is measured by the box method whereby the change in V_{OLIT} is divided by the temperature range; in this case, -40°C to +85°C = 125°C.
- 2. Thermal Hysteresis is the change in V_{OUT} measured @ T_A = 25°C after temperature cycling over a specified range, ΔT_A . V_{OUT} is read initially at T_A = 25°C for the device under test. The device is temperature cycled and a second V_{OUT} measurement is taken at 25°C. The difference between the initial V_{OUT} reading and the second V_{OUT} reading is then expressed in ppm. For ΔT_A = 125°C, the device under test is cycled from +25°C to +85°C to -40°C to +25°C.
- 3. Guaranteed by device characterization and/or correlation to other device tests.
- 4. FGA voltage reference long term drift is a logarithmic characteristic. Changes that occur after the first few hundred hours of operation are significantly smaller with time, asymptotically approaching zero beyond 1000 hours. Because of this decreasing characteristic, long term drift is specified in ppm/ $\sqrt{1kHrs}$.

Typical Performance Curves, 1.25V Reference V_{IN} = 3.0V, I_{OUT} = 0mA, T_A = 25°C

Unless Otherwise Specified

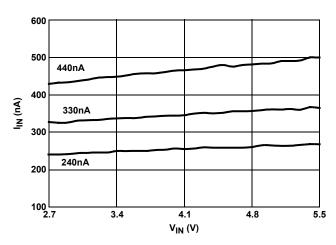


FIGURE 1. I_{IN} vs V_{IN} - 3 UNITS

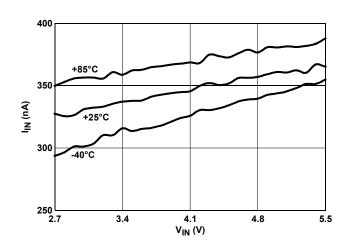


FIGURE 2. I_{IN} vs V_{IN} - 3 TEMPS

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Typical Performance Curves, 1.25V Reference V_{IN} = 3.0V, I_{OUT} = 0mA, T_A = 25°C Unless Otherwise Specified (Continued)

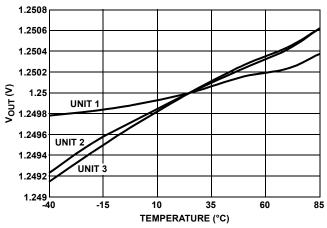


FIGURE 3. V_{OUT} vs TEMPERATURE NORMALIZED TO 25°C

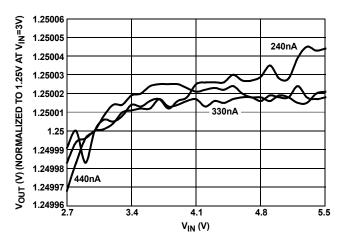


FIGURE 4. LINE REGULATION - 3 UNITS

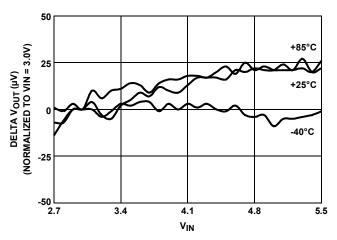


FIGURE 5. LINE REGULATION - 3 TEMPS

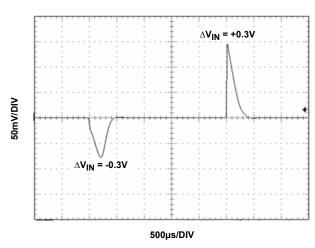


FIGURE 6. LINE TRANSIENT RESPONSE, $C_L = 0$ nF

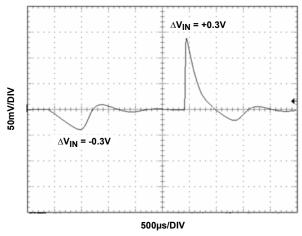


FIGURE 7. LINE TRANSIENT RESPONSE, $C_L = 1nF$

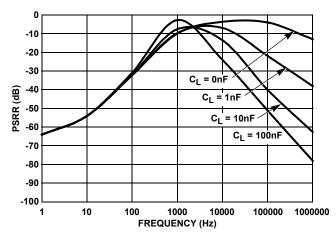


FIGURE 8. PSRR vs f vs CL

Typical Performance Curves, 1.25V Reference V_{IN} = 3.0V, I_{OUT} = 0mA, T_A = 25°C Unless Otherwise Specified **(Continued)**

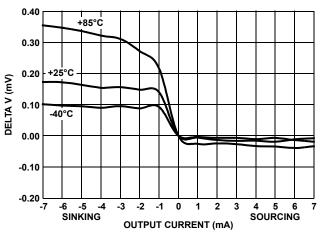


FIGURE 9. LOAD REGULATION vs TEMP

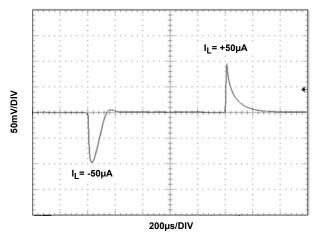


FIGURE 10. LOAD TRANSIENT RESPONSE @ I_L=50μA, C_L=1nF

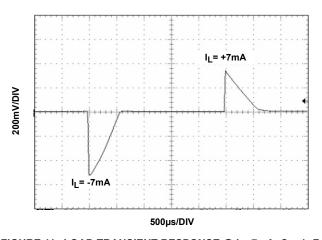


FIGURE 11. LOAD TRANSIENT RESPONSE @ IL=7mA, CL=1nF

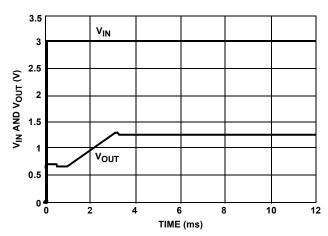


FIGURE 12. TURN-ON TIME @ $T_A = 25$ °C

Typical Performance Curves, 2.5V Reference

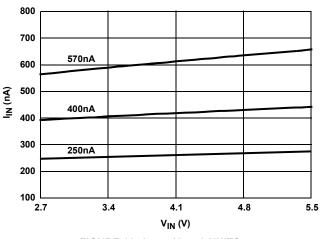
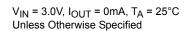


FIGURE 13. I_{IN} vs V_{IN} - 3 UNITS



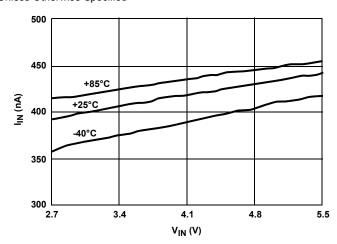
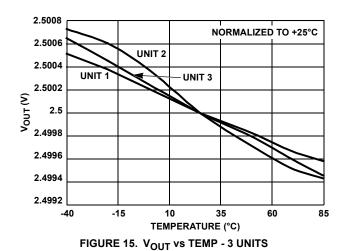


FIGURE 14. I_{IN} vs V_{IN} - 3 TEMPS

Typical Performance Curves, 2.5V Reference



 V_{IN} = 3.0V, I_{OUT} = 0mA, T_A = 25°C Unless Otherwise Specified (Continued)

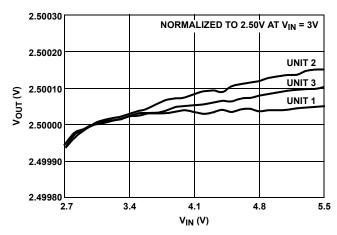


FIGURE 16. LINE REGULATION - 3 UNITS

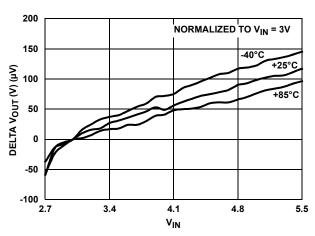


FIGURE 17. LINE REGULATION - 3 TEMPS

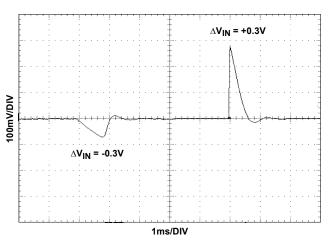
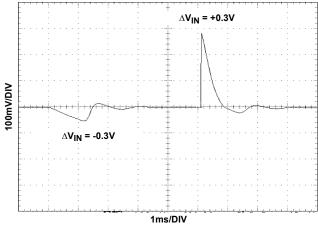


FIGURE 18. LINE TRANSIENT RESPONSE, C_L = 0nF





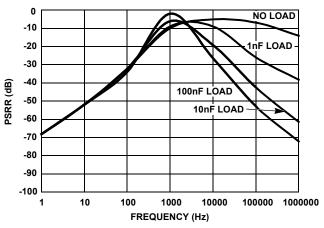


FIGURE 20. PSRR vs f vs CL

Typical Performance Curves, 2.5V Reference

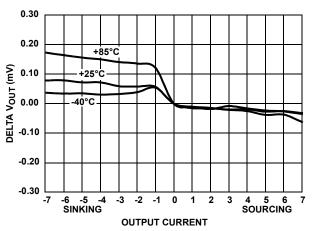


FIGURE 21. LOAD REGULATION vs TEMP

 V_{IN} = 3.0V, I_{OUT} = 0mA, T_A = 25°C Unless Otherwise Specified **(Continued)**

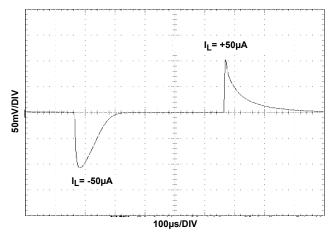


FIGURE 22. LOAD TRANSIENT RESPONSE @ I_L =50 μ A, C_L =1nF

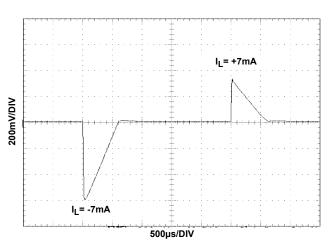


FIGURE 23. LOAD TRANSIENT RESPONSE @ I_L =7mA, C_L =1nF

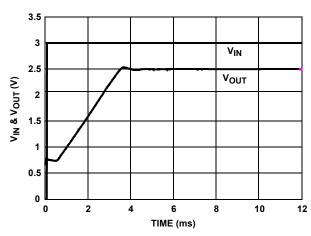


FIGURE 24. TURN-ON TIME @ $T_A = 25$ °C

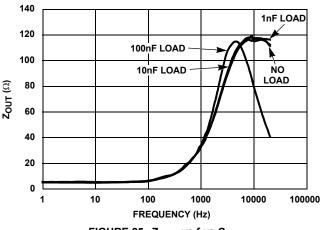


FIGURE 25. Z_{OUT} vs f vs C_L

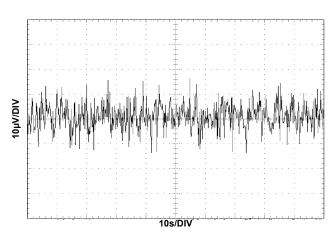


FIGURE 26. V_{OUT} NOISE

Applications Information

FGA Technology

The ISL60007 series of voltage references use the floating gate technology to create references with very low drift and supply current. Essentially the charge stored on a floating gate cell is set precisely in manufacturing. The reference voltage output itself is a buffered version of the floating gate voltage. The resulting reference device has excellent characteristics which are unique in the industry: very low temperature drift, high initial accuracy, and almost zero supply current. Also, the reference voltage itself is not limited by voltage bandgaps or zener settings, so a wide range of reference voltages can be programmed (standard voltage settings are provided, but customer-specific voltages are available).

The process used for these reference devices is a floating gate CMOS process, and the amplifier circuitry uses CMOS transistors for amplifier and output transistor circuitry. While providing excellent accuracy, there are limitations in output noise level and load regulation due to the MOS device characteristics. These limitations are addressed with circuit techniques discussed in other sections.

Nanopower Operation

Reference devices achieve their highest accuracy when powered up continuously, and after initial stabilization has taken place. This drift can be eliminated by leaving the power on continuously.

The ISL60007 is the first high precision voltage reference with ultra low power consumption that makes it possible to leave power on continuously in battery operated circuits. The ISL60007 consumes extremely low supply current due to the proprietary FGA technology. Supply current at room temperature is typically 400nA which is 1 to 2 orders of magnitude lower than competitive devices. Application circuits using battery power will benefit greatly from having an accurate, stable reference which essentially presents no load to the battery.

In particular, battery powered data converter circuits that would normally require the entire circuit to be disabled when not in use can remain powered up between conversions as shown in Figure 27. Data acquisition circuits providing 12 to 24 bits of accuracy can operate with the reference device continuously biased with no power penalty, providing the highest accuracy and lowest possible long term drift.

Other reference devices consuming higher supply currents will need to be disabled in between conversions to conserve battery capacity. Absolute accuracy will suffer as the device is biased and requires time to settle to its final value, or, may not actually settle to a final value as power on time may be short.

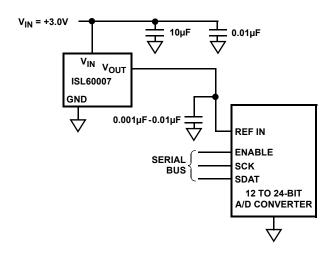


FIGURE 27.

Board Mounting Considerations

For applications requiring the highest accuracy, board mounting location should be reviewed. Placing the device in areas subject to slight twisting can cause degradation of the accuracy of the reference voltage due to die stresses. It is normally best to place the device near the edge of a board, or the shortest side, as the axis of bending is most limited at that location. Obviously mounting the device on flexprint or extremely thin PC material will likewise cause loss of reference accuracy.

Noise Performance and Reduction

The output noise voltage in a 0.1Hz to 10Hz bandwidth is typically 30µV_{P-P}. This is shown in the plot in the Typical Performance Curves. The noise measurement is made with a bandpass filter made of a 1 pole high-pass filter with a corner frequency at 0.1Hz and a 2-pole low-pass filter with a corner frequency at 12.6Hz to create a filter with a 9.9Hz bandwidth. Noise in the 10kHz to 1MHz bandwidth is approximately 400µV_{P-P} with no capacitance on the output, as shown in Figure 28. These noise measurements are made with a 2 decade bandpass filter made of a 1 pole highpass filter with a corner frequency at 1/10 of the center frequency and 1-pole low-pass filter with a corner frequency at 10 times the center frequency. Figure 28 also shows the noise in the 10kHz to 1MHz band can be reduced to about 50μV_{P-P} using a 0.001μF capacitor on the output. Noise in the 1kHz to 100kHz band can be further reduced using a 0.1µF capacitor on the output, but noise in the 1Hz to 100Hz band increases due to instability of the very low power amplifier with a 0.1µF capacitance load. For load capacitances above 0.001µF the noise reduction network shown in Figure 29 is recommended. This network reduces noise significantly over the full bandwidth. As shown in Figure 28, noise is reduced to less than $40\mu V_{P-P}$ from 1Hz to 1MHz using this network with a 0.01µF capacitor and a $2k\Omega$ resistor in series with a 10μ F capacitor.

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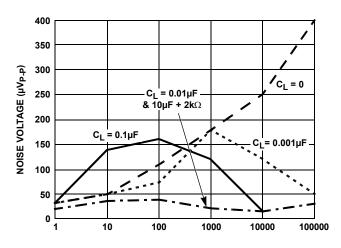
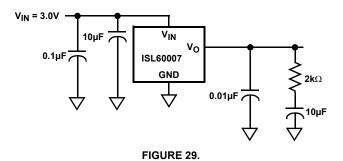


FIGURE 28. NOISE REDUCTION



Turn-On Time

The ISL60007 devices operate with ultra-low supply current and thus the time to bias up internal circuitry to final values will be longer than with references that require higher

current. Normal turn-on time is typically 4ms. This is shown in Figure 30. Since devices can vary in supply current down to 250nA, turn-on time can last up to about 6ms. Care should be taken in system design to include this delay before measurements or conversions are started.

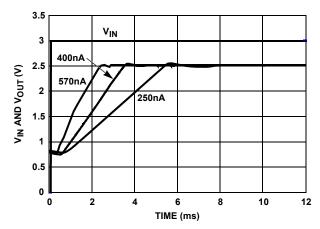


FIGURE 30. TURN-ON TIME (+25°C)

Temperature Coefficient

The limits stated for temperature coefficient (tempco) are governed by the method of measurement. The overwhelming standard for specifying the temperature drift of a reference is to measure the reference voltage at two temperatures, take the total variation, ($V_{HIGH} - V_{LOW}$), and divide by the temperature extremes of measurement ($T_{HIGH} - T_{LOW}$). The result is divided by the nominal reference voltage (at T = 25°C) and multiplied by 10^6 to yield ppm/°C. This is the "Box" method for specifying temperature coefficient.

Typical Application Circuits

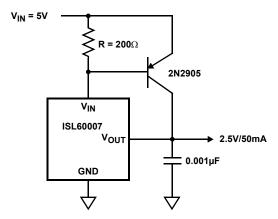


FIGURE 31. PRECISION 2.5V, 50mA REFERENCE

Typical Application Circuits (Continued)

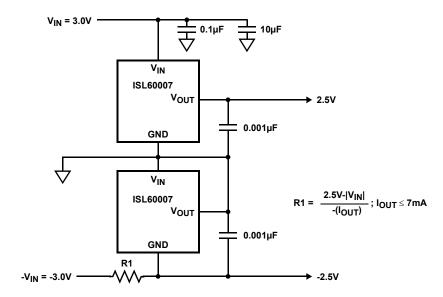


FIGURE 32. ±2.5V DUAL OUTPUT, HIGH ACCURACY REFERENCE

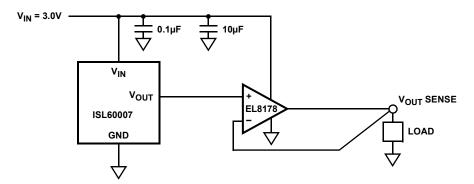


FIGURE 33. KELVIN SENSED LOAD

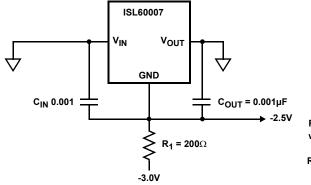


FIGURE 34. NEGATIVE VOLTAGE REFERENCE

$$\begin{split} &R_1 \text{ LIMITS MAX LOAD CURRENT} \\ &\text{with } R_1 = 200\Omega; \ I_{LOAD \ MAX} = 2.5\text{mA} \\ &R1 = \ \frac{2.5\text{V-}|V_{IN}|}{-(I_{OUT})} \ ; \ I_{OUT} \leq 7\text{mA} \end{split}$$

Typical Application Circuits (Continued)

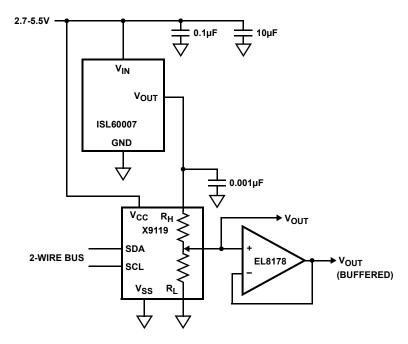
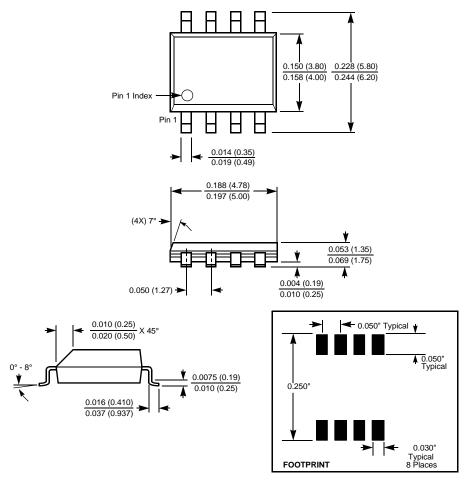


FIGURE 35. 2.5V FULL SCALE LOW-DRIFT 10-BIT ADJUSTABLE VOLTAGE SOURCE

Packaging Information

8-Lead Plastic, SOIC, Package Code B8



NOTE: All dimensions in inches (in parentheses in millimeters).

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